TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX138FN

Low-Voltage 3-to-8 Line Decoder with 5-V Tolerant Inputs and Outputs

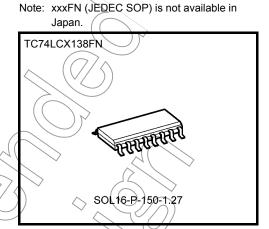
The TC74LCX138 is a high-performance CMOS 3-to-8 decoder. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for inputs.

When the device is enabled, 3 binary select inputs (A, B and C) determine which one of the outputs $(\overline{Y}0 \cdot \overline{Y}7)$ will go low. When enable input G1 is held low or either $\overline{G}2A$ or $\overline{G}2B$ is held high, decoding function is inhibited and all outputs go high.

 \overline{G} 1, \overline{G} 2A, and \overline{G} 2B inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

All inputs are equipped with protection circuits against static discharge.



Weight

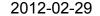
SOL16-P-150-1.27

: 0.12 g (typ.)

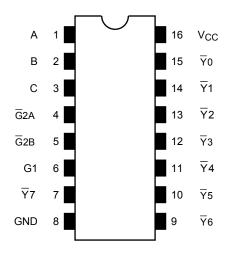
Features

- Low-voltage operation: $V_{CC} = 1.65$ to 3.6 V
- High-speed operation: $t_{pd} = 6.0 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- Ouput current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: $> \pm 500 \text{ mA}$
- Available in JEDEC SOP
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 138 type

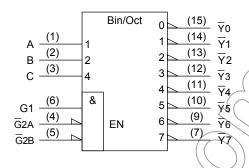
Note: The Electrical Characteristics of $V_{CC}=1.8\pm0.15V$ is only applicable for products which manufactured from January 2009 onward.

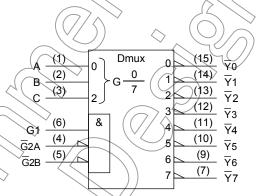


Pin Assignment (top view)



IEC Logic Symbol





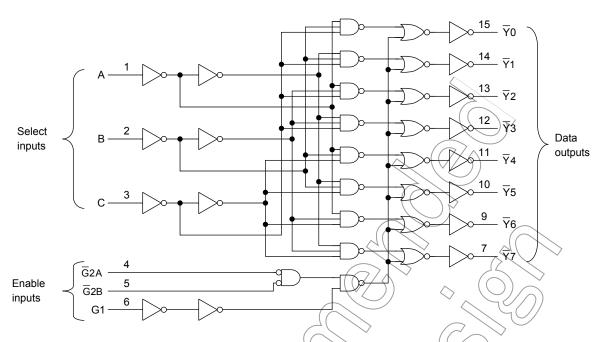
Truth Table

							1 1							
	Inputs						Outputs							
Enable			Select (//		Y ₀	<u></u>		KI//	¥4	_ Y5	<u>-</u> Y6	_ Y7	Selected Output	
G1	G ₂ A	G2B	9/	В	4		11	12	7	7	10	10	1 /	
L	Х	Х	(X/	X	X	Н	H	H	(H)	Н	Н	Н	Н	None
Х	Н	Х	X	X	Х	H/	7	¥	T	Н	Н	Н	Н	None
Х	Х	Н	×	X	> x	Н	<u> </u>	E	Н	Н	Н	Н	Н	None
Н	L		Ľ	L	L	Ш	Έ	$\not au angle$	Η	Η	Η	Η	Η	\ \{\frac{1}{2}}0
Н	L)<))) L	Н	H	L	Н	Н	Н	Н	Н	Н	Ÿ1
Н	L		1	Н	L	TT/	Н	L	Н	Н	Н	Н	Н	Ÿ2
Н	/4))		H	H	 	\	Η	L	Η	Η	Η	Η	- 73
H	4	4	Η	Ĺ	\Diamond	<u> </u>	Η	Η	Η	Ш	Η	Η	Η	Y 4
Н	7]	Η	LŻ	$\not \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \!$) =	Η	Η	Η	Η	L	Η	Η	Y 5
Н		L	Н	Н	7	> н	Н	Н	Н	Н	Н	L	Н	Y 6
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Y 7

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X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

			$-(\bigcirc)$
Characteristics	Symbol	Rating	Unit
Power supply voltage	v _{cc} <	0.5 to 7.0	_v_
DC input voltage	VIN	-0.5 to 7.0) \flat
		-0.5 to 7.0 (Note 2)	//
DC output voltage	VOUT	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	₩K	-50	mA
Output diode current	// Slok	±50 (Note 4)	mA
DC output current	Yout	±50	mA
Power dissipation	→ P _D	180	mW
DC V _{CC} /ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating range (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: $V_{CC} = 0 V$

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	1.65 to 3.6	V
Power supply voltage	VCC	1.5 to 3.6 (Note 2)	v
Input voltage	V _{IN}	0 to 5.5	V <
Output voltage	Vout	0 to 5.5 (Note 3)	V
Output voltage	VOUI	0 to V _{CC} (Note 4)	v
Output ourropt	la/la.	±24 (Note 5)	mA
Output current	I _{OH} /I _{OL}	±12 (Note 6)	mA (
Operating temperature	T _{opr}	-40 to 85	~c
Input rise and fall time	dt/dv	0 to 10 (Note 7)	(ns/V)

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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Note 2: Data retention only

Note 3: $V_{CC} = 0 V$

Note 4: High or low state

Note 5: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$

Note 6: $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$

Note 7: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristi	ics	Symbol	Test Con	dition	V 00	Min	Max	Unit	
				V _{CC} (V)	V ×00				
						V _{CC} ×0.9			
	H-level	V _{IH}	_		2.3 to 2.7	> 1.7			
Input voltage				2.7 to 3.6	2.0	_	V		
input voltage					1.65 to 2.3		V _{CC} × 0.1	v	
	L-level	V _{IL}	_		2.3 to 2.7))—	0.7		
				2.7 to 3.6	_	0.8			
				I _{OH} = -100 μA	1.65 to 3.6	V _{CC} -0.2	_		
			V _{IN} = V _{IH} or V _{IL}	I _{OH} = -4 mA	1.65	1.05	1		
	H-level	V _{ОН}		$I_{OH} = -8 \text{ mA}$	2.3	1,7			
				I _{OH} = -12/m/A	2.7	(2:2)	<u></u>		
				loн = -18 mA	3.0	2.4	$\bigcirc)-$		
Q				OH = -24 mA	3.0	2.2	/ _	.,	
Output voltage			40	I _{OL} = 100 μA	1.65 to 3.6	\bigcap	0.2	V	
				TOL = 4 mA	1.65	<u> </u>	0.45		
	L-level) _{OL} = 8 mA	(2,3)	_	0.7		
		V _{OL}	VIN = VIH OLVID	I _{OL} = 12 mA	2.7	_	0.4		
				I _{OL} = 16 mA	3.0	_	0.4		
				I _{OL} = 24 mA	//3.0	_	0.55		
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V	\wedge	1.65 to 3.6	_	±5.0	μА	
Power-off leakage curr	ent	lofe	V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μА	
			V _{IN} = V _{CC} or GND	1.65 to 3.6	_	10.0			
Quiescent supply curre	ant .	(Jecs)	V _{IN} = 3.6 to 5.5 V	1.65 to 3.6	_	±10.0	μА		
Increase in Icc per inpu	ut//	Δlcc	V _{IH} = V _{CC} - 0.6 V		2.7 to 3.6	_	500		

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AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
			1.8±0.15	_	25.0	ns
Propagation delay time	t_{pLH}	Signary 4. Signary 2	2.5±0.2		8.0	
(A, B, C- \overline{Y})	t_{pHL}	Figure 1, Figure 2	2.7		7.0	
			3.3 ± 0.3	1.5	6.0	
	t _{pLH}		1.8±0.15) [25.0	
Propagation delay time		Figure 1, Figure 2	2.5±0.2	_	9.0	ns
(G1- \overline{Y})	t_{pHL}	Trigule 1, Figure 2	2.7	_	8.0	
			3.3 ± 0.3	1.5	7.0	
			1.8±0.15	1	25.0	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5±0.2	\mathcal{A}	8.0	ns
(G 2 - Y)		Tigure 1, Figure 2	2.7	X	7.0	
			3.3 ± 0.3	1.5	6.0	
Output to output skew	t _{osLH}	(Note)	2.7	(4)	/ _	ns
output to output show	t _{osHL}	(Note)	3.3 ± 0.3	\$	1.0	113

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$

Dynamic Switching Characteristics ($Ta = 25^{\circ}C$, input; $t_r = t_f = 2.5 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	VOLP	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	IVOFAI	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN} <	_	3.3	7	pF
Output capacitance	C _{OUT}	_	0	8	pF
Power dissipation capacitance	C _{PD}	$f_{IN} = 10 \text{ MHz}$ (No	e) 3.3	25	pF

Note: Cpp is defined as the value of the internal equivalent capacitance which is calculated from the operating

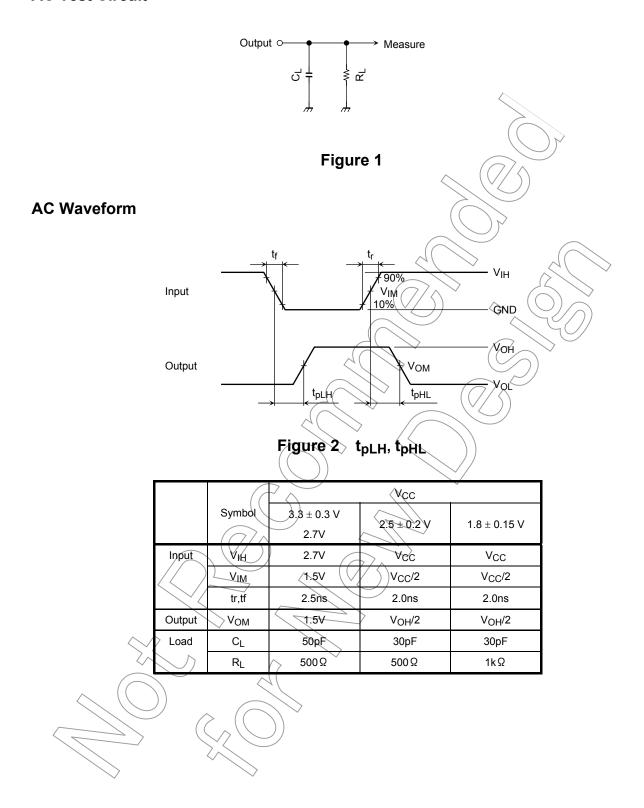
current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD · VCC · fIN + ICC

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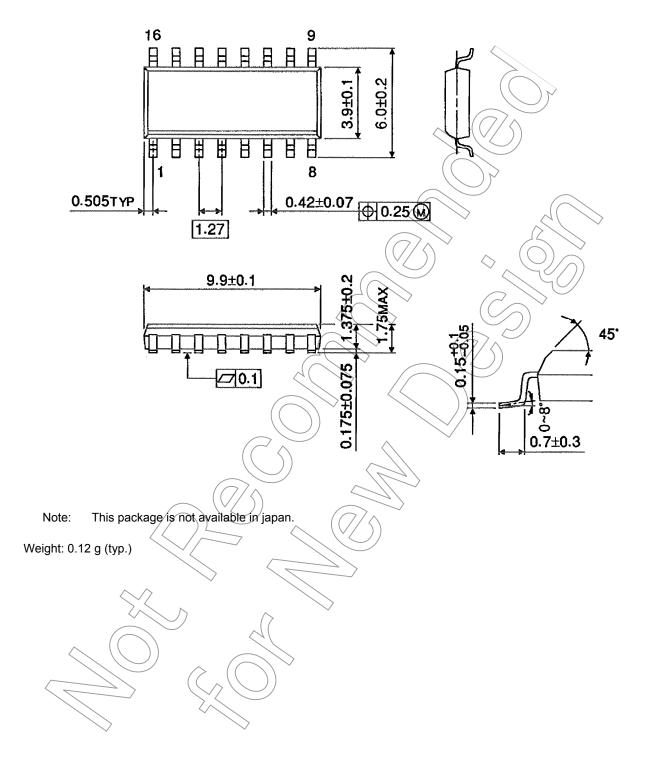
AC Test Circuit



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Package Dimensions (Note)

SOL16-P-150-1.27 Unit: mm



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